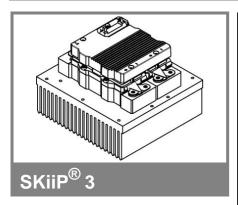
SKiiP 1213GB123-2DL



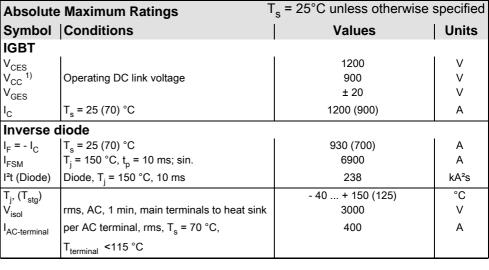
2-pack-integrated intelligent Power System

Power section SKiiP 1213GB123-2DL

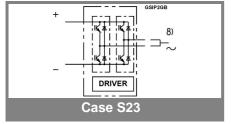
Data

Power section features

- SKiiP technology inside
- Trench IGBTs
- CAL HD diode technology
- · Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 60068-1 (climate) 40/125/56)
- UL recognized file no. E63532
- with assembly of suitable MKP capacitor per terminal
- 8) AC connection busbars must be connected by the user; copper busbars available on request



Characteristics			T _s = 25°C unless otherwise specified						
Symbol	Symbol Conditions			min.	typ.	max.	Units		
IGBT									
V _{CEsat}	I _C = 600 A measured at t	., T _j = 25 (1 terminal	25) °C;			1,7 (1,9)	2,1	V	
V_{CEO}	$T_i = 25 (12)$	25) °C; at to	erminal			0,9 (0,8)	1,1 (1)	V	
r_{CE}	$T_i = 25 (12)$	25) °C; at to	erminal			1,3 (1,8)	1,7 (2,2)	mΩ	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = V_{CES},$ $T_i = 25 (125) \text{ °C}$					2,4 (72)		mA	
$E_{on} + E_{off}$	$I_{\rm C}^{\rm J} = 600 {\rm A}$		0 V			221		mJ	
	T _j = 125 °C	C, V _{CC} = 90	00 V			390		mJ	
R _{CC+EE}	terminal cl	hip, T _i = 25	S°C			0,25		mΩ	
L_{CE}	top, bottor	n				6		nΗ	
C _{CHC}	per phase	, AC-side				3,4		nF	
Inverse o									
$V_F = V_{EC}$	I _F = 600 A measured at t	, T _j = 25 (1 terminal	25) °C			1,5 (1,5)	1,8	V	
V _{TO}	T _i = 25 (12	25) °C				0,9 (0,7)	1,1 (0,9)	V	
r_T	$T_j = 25 (12)$ $T_j = 25 (12)$					1 (1,3)	1,1 (1,5)	mΩ	
E _{rr}	$I_{\rm C} = 600 \text{A}$	$V_{CC} = 60$	0 V			42		mJ	
	T _j = 125 °C	$C, V_{CC} = 90$	00 V			56		mJ	
Mechani	cal data								
M_{dc}	DC termin				6		8	Nm	
M_{ac}	AC termin	-			13		15	Nm	
W		SKiiP® 3 System w/o heat sink				1,7		kg	
W	heat sink	heat sink				5,4			
Thermal characteristics (PX16 heat sink with fan SKF16B-230-1); "s" reference to heat sink; "r" reference to built-in temperature sensor (acc. IEC									
60747-15		· · · · ·					, , , , ,		
$R_{th(j-s)l}$	per IGBT						0,03	K/W	
$R_{th(j-s)D}$	per diode						0,058	K/W	
Z_{th}	R _i (mK/W)	R _i (mK/W) (max. values)				tau _i (s)			
	1	2	3	4	1	2	3	4	
$Z_{th(j-r)I}$	9,8	16,4	3,8	0	0,37	0,06	0,01	1	
$Z_{th(j-r)D}$	10	24	24	36	50	5	0,25	0,04	



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2,3

160

53

9

0,4

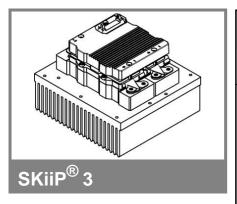
20,3

7,1

4,3

 $Z_{th(r-\underline{a})}$

SKiiP 1213GB123-2DL



2-pack-integrated intelligent Power System

2-pack integrated gate driver SKiiP 1213GB123-2DL

Data

Gate driver features

- · CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings	a = 25°C unless otherwise specified		
Symbol	Conditions	Values	Units	
V_{S2}	unstabilized 24 V power supply	30	V	
V_{i}	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
V_{isollO}	input / output (AC, rms, 2s)	3000	V	
V _{isoIPD}	partial discharge extinction voltage, rms, Q _{PD} ≤10 pC;	1170	V	
V _{isol12}	output 1 / output 2 (AC, rms, 2s)	1500	V	
f _{sw}	switching frequency	15	kHz	
f _{out}	output frequency for I _{peak(1)} =I _C	15	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C	

Characte	eristics	(T _a =			= 25 °C)
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	278+25*f/kHz+0,00022*(I _{AC} /A) ²			mA
V _{iT+}	input threshold voltage (High)			12,3	V
V_{iT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
$t_{d(off)IO}$	input-output turn-off propagation time		1,3		μs
t _{pERRRESET}	error memory reset time		9		μs
t_{TD}	top / bottom switch interlock time		3,3		μs
I _{analogOUT}	max. 5mA; 8 V corresponds to 15 V supply		1200		Α
I _{s1out}	voltage for external components max. load current			50	mA
I _{TRIPSC}	over current trip level				
	(I _{analog} OUT = 10 V)		1500		Α
T_{tp}	over temperature protection	110		120	°C
U _{DCTRIP}	U_{DC} -protection ($U_{analog OUT} = 9 V$);		not implemented	i	V
	(option for GB types)				

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